

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	DONG-SHENG LI	05/28/2019
<b>RECEIVING PARTY DATA</b>		
<b>Name:</b>	SIMPOWER TECHNOLOGY INC.	
<b>Street Address:</b>	9F.-1, NO.461, SEC. 6, NANJING E. RD., NEIHU DIST.	
<b>City:</b>	TAIPEI CITY	
<b>State/Country:</b>	TAIWAN	
<b>Postal Code:</b>	11469	
<b>PROPERTY NUMBERS Total: 1</b>		
<b>Property Type</b>	<b>Number</b>	
<b>Application Number:</b>	16429084	
<b>CORRESPONDENCE DATA</b>		
<b>Fax Number:</b>		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
<b>Email:</b>	ahuang@pypat.com	
<b>Correspondent Name:</b>	ANGELA HUANG	
<b>Address Line 1:</b>	19925 STEVENS CREEK BLVD., STE. 100	
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<b>ATTORNEY DOCKET NUMBER:</b>	AN9010N_089-16-0024.IUS	
<b>NAME OF SUBMITTER:</b>	ANGELA HUANG	
<b>SIGNATURE:</b>	/Angela Huang/	
<b>DATE SIGNED:</b>	11/20/2019	
<b>Total Attachments: 2</b>		
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source=AN9010N_Assignment_Agreement#page2.tif		

THIS AGREEMENT is made  
on

Date May28, 2019

by and between

Inventors  
Address

LI, DONG-SHENG  
9F.-1, NO.461, SEC. 6, NANJING E. RD.,  
NEIHU DIST.,TAIPEI CITY 11469  
TAIWAN

and

Assignee  
Address

SIMPOWER TECHNOLOGY INC.  
9F.-1, NO.461, SEC. 6, NANJING E. RD.,  
NEIHU DIST.,TAIPEI CITY 11469  
TAIWAN

WHEREAS, the undersigned have invented certain new and useful improvements in the below invention (the "Invention"):

Title of the Invention

MULTI-FUNCTIONAL HUB  
INTEGRATED WITH AC POWER  
SUPPLY

NOW THEREFORE, in consideration of the mutual promises, covenants, warranties, and other good and valuable consideration set forth herein, the receipt of which is hereby acknowledged, and in accordance with applicable law, the undersigned:

1. Hereby sell, assign and transfer to Assignee its successors, assigns and legal representatives, the entire right, title and interest for the United States and all-foreign countries, in and to any and all inventions which are disclosed in the application for united States Letters Patent executed of even date herewith and entitled above and in and to said application and all divisional, continuing, substitute, renewal, reissue and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of the said inventions; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said inventions including the right to apply for patent rights in each foreign country and all rights to priority;
2. Hereby agree that said Assignee may apply for and receive Letters Patent for said inventions in its own name; and when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, agree to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions; execute all rightful oaths, assignments, power of attorney and other papers, communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said inventions and the history thereof; and generally do everything possible which said Assignee, its successors, assignees or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said inventions and for vesting title to said inventions and all applications for patents and all patents on said inventions, in said Assignee, its successors, assigns and legal representatives;
3. Hereby request the Honorable Commissioner of Patents to issue said Letters Patent to said Assignee; and
4. Covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned and that full right to convey the same as herein expressed is possessed by the undersigned.

[SIGNATURE PAGE FOLLOWS]

IN WITNESS WHEREOF, executed by the Inventor on the date opposite the Inventor names.

LEGAL NAME OF INVENTOR

Inventor: LI, DONG SHENG

Signature:

Date: May 28, 2019